

SOT-23 Plastic-Encapsulate MOSFETS

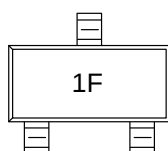
FEATURE

- TrenchFET Power MOSFET
- Excellent $R_{DS(on)}$ and Low Gate Charge

APPLICATION

- DC/DC Converter
- Load Switch for Portable Devices
- Battery Switch

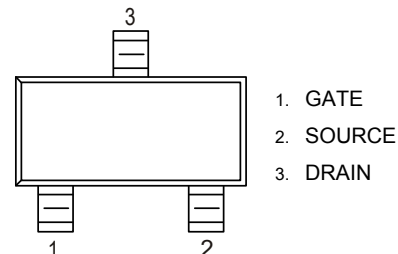
Marking



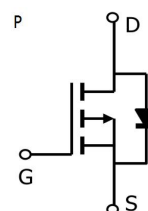
1F = Device code

SOT-23

RoHS
COMPLIANT



Equivalent Circuit



ABSOLUTE MAXIMUM RATINGS ($T_a=25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-12	V
Gate-Source Voltage	V_{GS}	± 8	V
Continuous Drain Current	I_D	-6 ^a	A
Pulsed Drain Current ($t=300\mu\text{s}$)	I_{DM}	-20	A
Power Dissipation	P_D	0.35 ^b	W
		1.1 ^a	W
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	357 ^b	$^\circ\text{C/W}$
		113 ^a	$^\circ\text{C/W}$
Operation Junction and Storage Temperature Range	T_J, T_{STG}	-55~ +150	$^\circ\text{C}$

a. Device mounted on FR-4 substrate board, with minimum recommended pad layout, single side.

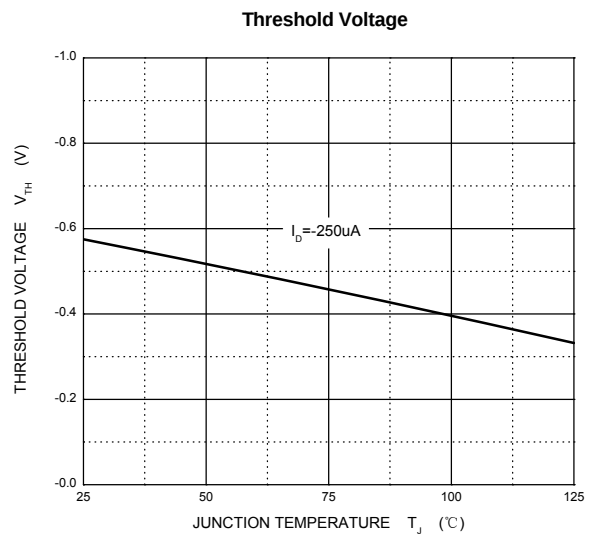
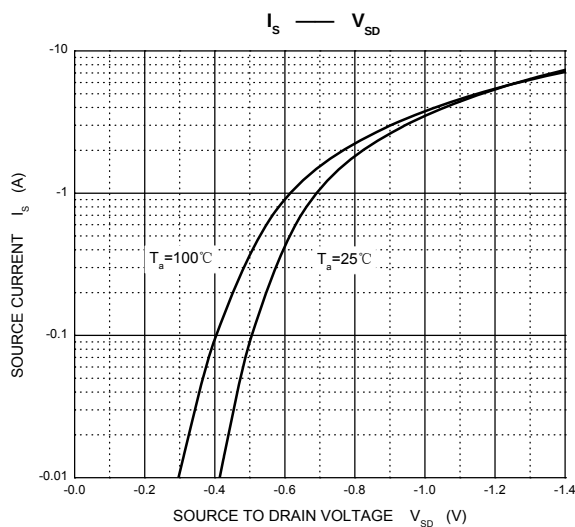
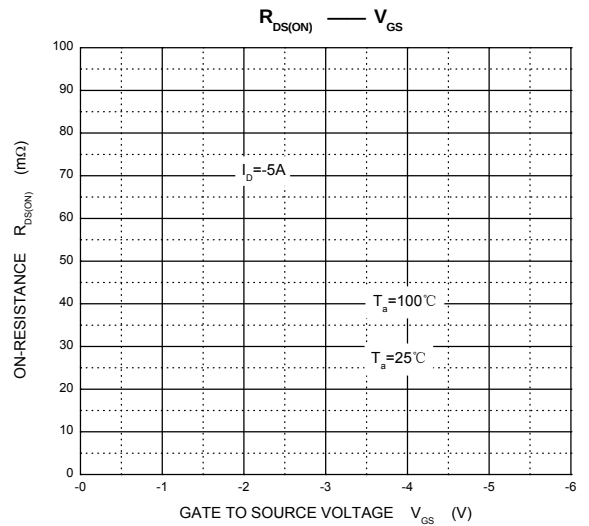
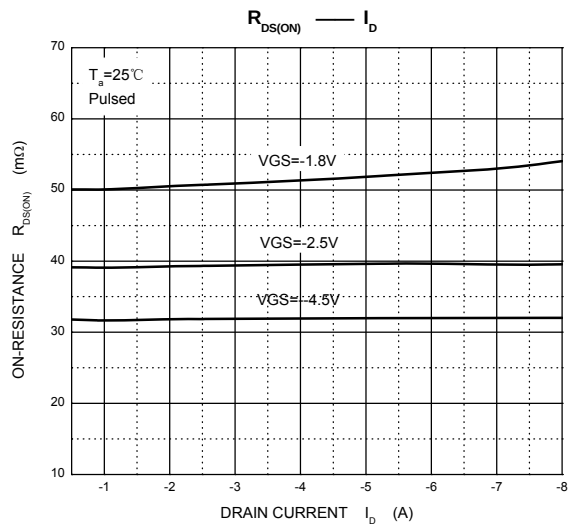
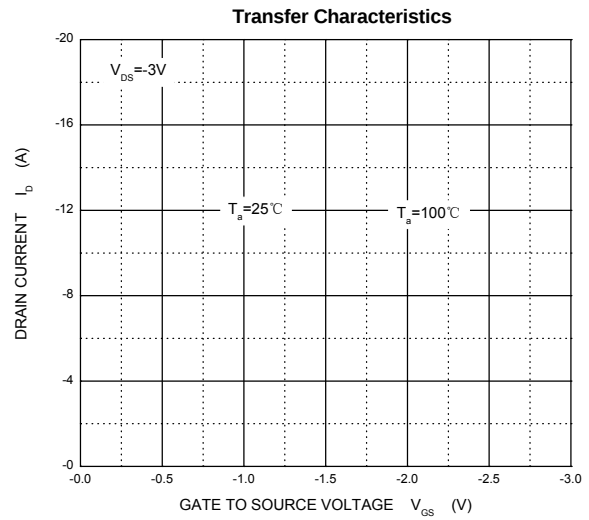
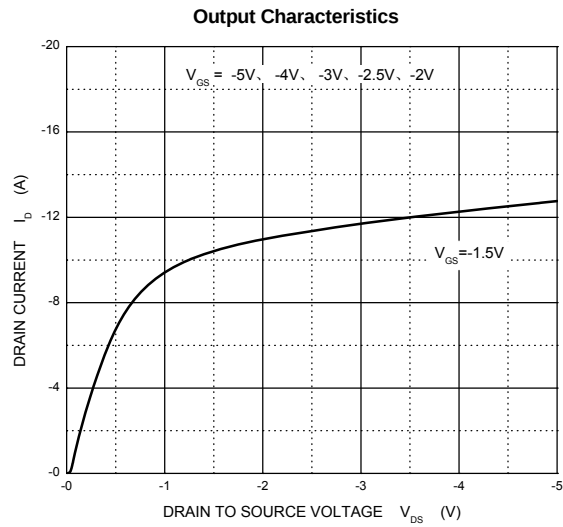
b. Device mounted on no heat sink.

Electrical Characteristics (Ta=25°C unless otherwise specified)

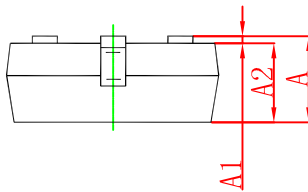
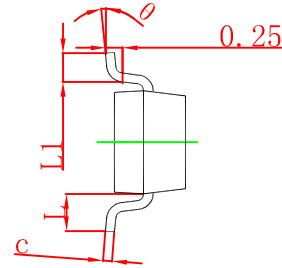
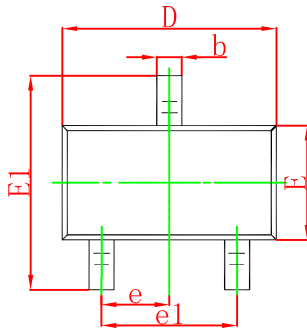
Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-source breakdown voltage	V _{(BR)DSS}	V _{GS} = 0V, I _D =-250μA	-12			V
Zero gate voltage drain current	I _{DSS}	V _{DS} =-12V,V _{GS} = 0V			-1	μA
Gate-body leakage current	I _{GSS}	V _{GS} =±8V, V _{DS} = 0V			±0.1	μA
Gate threshold voltage (note 1)	V _{GS(th)}	V _{DS} =V _{GS} , I _D =-250μA	-0.4		-1	V
Drain-source on-resistance (note 1)	R _{DS(on)}	V _{GS} =-4.5V, I _D =-5A			35	mΩ
		V _{GS} =-2.5V, I _D =-4.3A			45	
		V _{GS} =-1.8V, I _D =-1A			63	
Forward tranconductance (note 1)	g _{FS}	V _{DS} =-5V, I _D =-5A		18		S
Dynamic characteristics (note 2)						
Input Capacitance	C _{iss}	V _{DS} =-6V,V _{GS} =0V,f =1MHz		1275		pF
Output Capacitance	C _{oss}			255		pF
Reverse Transfer Capacitance	C _{rss}			236		pF
Gate resistance	R _g	f =1MHz	1.9		19	Ω
Total Gate Charge	Q _g	V _{DS} =-6V,V _{GS} =-4.5V,I _D =-5A		14	21	nC
Gate-Source Charge	Q _{gs}			2.3		nC
Gate-Drain Charge	Q _{gd}			3.6		nC
Turn-on delay time	t _{d(on)}	V _{DD} =-6V,V _{GEN} =-4.5V,I _D =-4A R _L =6Ω,R _{GEN} =1Ω		26	40	ns
Turn-on rise time	t _r			24	40	ns
Turn-off delay time	t _{d(off)}			45	70	ns
Turn-off fall time	t _f			20	35	ns
Source-Drain Diode characteristics						
Diode forward current	I _S	T _C =25°C			-1.4	A
Diode pulsed forward current	I _{SM}				-20	A
Diode Forward voltage (note 1)	V _{DS}	V _{GS} =0V, I _S =-4A			-1.2	V
Diode reverse recovery time (note 2)	t _{rr}	I _F =-4A,dI/dt=100A/μs		24	48	ns
Diode reverse recovery charge (note 2)	Q _{rr}			8	16	nC

- Notes :**
1. Pulse test; pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
 2. Guaranteed by design, not subject to production testing.

Typical Characteristics

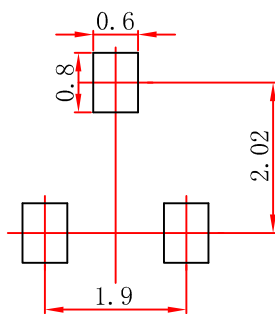


SOT-23 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.400	0.035	0.055
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.350	0.500	0.014	0.020
c	0.080	0.190	0.003	0.007
D	2.700	3.100	0.106	0.122
E	1.200	1.650	0.047	0.065
E1	2.200	3.000	0.087	0.118
e	0.950 TYP		0.037 TYP	
e1	1.780	2.040	0.070	0.080
L	0.550 REF		0.022 REF	
L1	0.200	0.500	0.008	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout



Note:

1. Controlling dimension: in/millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.